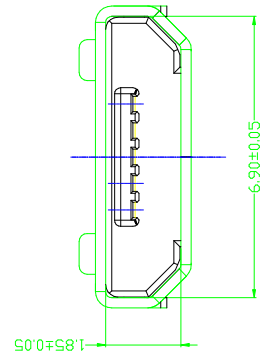
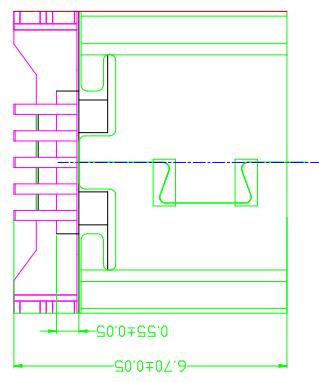
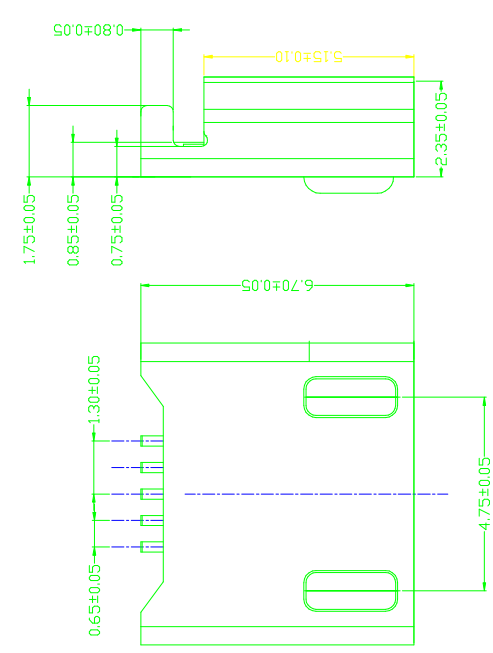
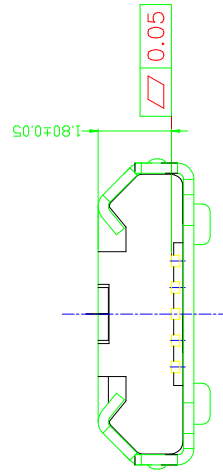


修改序号	修改说明	签名	日期
A/0			



Note:

1. Material:
 - 1.1 Housing: High temperature thermoplastic with g. f, UL94v-0
 - 1.2 Contact: copper alloy, t=0.20mm
 - 1.3 Shell: copper alloy, t=0.25mm
2. Specification:
 - 2.1 Current rating: 1 A Max.
 - 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
 - 2.3 Contact resistance: 50 mΩ Max.
 - 2.4 Insulation resistance: 100 MW Min.
 - 2.5 Total mating force: 3.57 Kgf Max.
 - 2.6 Total unmating force: 1.0 Kgf Min. 0.81~2.05 Kgf Min. after 3000 insertion/extraction cycles
 - 2.7 Temperature range: -30. C~80. C



深圳市虹康科技有限公司

尺寸	允许公差
X.	±0.50
.X	±0.20
.XX	±0.10
.XXX	±0.03
角度	±1.00°

图纸名称:
MICRO 5P/F B TYPE 沉板1.6无脚无边凸包

图纸类型
产品工程图

设计	SUN YUAN	2016-12-06	产品料号	SHK-20047
审核			视图	
			版号:	A/0